

UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
United States Patent and Trademark Office
Address: COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, Virginia 22313-1450

DATE MAILED: 03/31/2005

APPLICATION NO.	LICATION NO. FILING DAT		FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/027,476	12/2	1/2001	Jimmy Kuo Chen	276440-21	9965
50905	7590	03/31/2005	5 E)		INER
N. KENNETH BURRASTON				NGUYEN, DONGHAI D	
KIRTON & N P.O. BOX 45				ART UNIT	PAPER NUMBER
SALT LAKE		84145-0120		3729	

Please find below and/or attached an Office communication concerning this application or proceeding.



Application No. Applicant(s) **Advisory Action** 10/027.476 CHEN, JIMMY KUO Before the Filing of an Appeal Brief Examiner **Art Unit** 3729 Donghai D. Nguyen -- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --THE REPLY FILED 17 March 2005 FAILS TO PLACE THIS APPLICATION IN CONDITION FOR ALLOWANCE. 1. X The reply was filed after a final rejection, but prior to filing a Notice of Appeal. To avoid abandonment of this application, applicant must timely file one of the following replies: (1) an amendment, affidavit, or other evidence, which places the application in condition for allowance; (2) a Notice of Appeal (with appeal fee) in compliance with 37 CFR 41.31; or (3) a Request for Continued Examination (RCE) in compliance with 37 CFR 1.114. The reply must be filed within one of the following time periods: a) The period for reply expires <u>3</u> months from the mailing date of the final rejection. b) The period for reply expires on: (1) the mailing date of this Advisory Action, or (2) the date set forth in the final rejection, whichever is later. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of the final rejection. Examiner Note: If box 1 is checked, check either box (a) or (b). ONLY CHECK BOX (b) WHEN THE FIRST REPLY WAS FILED WITHIN TWO MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f). Extensions of time may be obtained under 37 CFR 1.136(a). The date on which the petition under 37 CFR 1.136(a) and the appropriate extension fee have been filed is the date for purposes of determining the period of extension and the corresponding amount of the fee. The appropriate extension fee under 37 CFR 1.17(a) is calculated from: (1) the expiration date of the shortened statutory period for reply originally set in the final Office action; or (2) as set forth in (b) above, if checked. Any reply received by the Office later than three months after the mailing date of the final rejection, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b). NOTICE OF APPEAL 2. The reply was filed after the date of filing a Notice of Appeal, but prior to the date of filing an appeal brief. The Notice of Appeal was filed on 17 March 2005. A brief in compliance with 37 CFR 41.37 must be filed within two months of the date of filing the Notice of Appeal (37 CFR 41.37(a)), or any extension thereof (37 CFR 41.37(e)), to avoid dismissal of the appeal. Since a Notice of Appeal has been filed, any reply must be filed within the time period set forth in 37 CFR 41.37(a). **AMENDMENTS** 3. The proposed amendment(s) filed after a final rejection, but prior to the date of filing a brief, will not be entered because (a) They raise new issues that would require further consideration and/or search (see NOTE below): (b) They raise the issue of new matter (see NOTE below): (c) They are not deemed to place the application in better form for appeal by materially reducing or simplifying the issues for appeal; and/or (d) They present additional claims without canceling a corresponding number of finally rejected claims. NOTE: _____. (See 37 CFR 1.116 and 41.33(a)). 4. The amendments are not in compliance with 37 CFR 1.121. See attached Notice of Non-Compliant Amendment (PTOL-324). 5. Applicant's reply has overcome the following rejection(s): 6. Newly proposed or amended claim(s) _____ would be allowable if submitted in a separate, timely filed amendment canceling the non-allowable claim(s). 7. For purposes of appeal, the proposed amendment(s): a) will not be entered, or b) will be entered and an explanation of how the new or amended claims would be rejected is provided below or appended. The status of the claim(s) is (or will be) as follows: Claim(s) allowed: None. Claim(s) objected to: None. Claim(s) rejected: 1-12 and 16-20. Claim(s) withdrawn from consideration: None. AFFIDAVIT OR OTHER EVIDENCE 8. The affidavit or other evidence filed after a final action, but before or on the date of filing a Notice of Appeal will not be entered because applicant failed to provide a showing of good and sufficient reasons why the affidavit or other evidence is necessary and was not earlier presented. See 37 CFR 1.116(e). 9. The affidavit or other evidence filed after the date of filing a Notice of Appeal, but prior to the date of filing a brief, will not be entered because the affidavit or other evidence failed to overcome all rejections under appeal and/or appellant fails to provide a showing a good and sufficient reasons why it is necessary and was not earlier presented. See 37 CFR 41.33(d)(1). 10. The affidavit or other evidence is entered. An explanation of the status of the claims after entry is below or attached. REQUEST FOR RECONSIDERATION/OTHER 11. The request for reconsideration has been considered but does NOT place the application in condition for allowance because: See Continuation Sheet.

U.S. Patent and Trademark Office PTOL-303 (Rev. 9-04)

13. Other: ___ . ·

12. Note the attached Information Disclosure Statement(s). (PTO/SB/08 or PTO-1449) Paper No(s).

A. DEXTER TUGBAI PRIMARY EXAMINER Continuation of 11. In the response After Final filed on March 17, 2005, Applicant argues that Chan et al do not disclose "heating the interconnect structure without substantially heating the substrate"; however Chen et al disclose the step of apply localized heating to the interconnect structures (pads 34/35 or ferromagnetic balls 30/31; see Col. 4, lines 26-28) on the non-conductive substrate that means only the structures having ferromagnetic coated thereon are heated by the oscillating electromagnetic field without substantially heating other structures that do not have the ferromagnetic material coated thereon (see Col. 3, lines 18-27). Therefore, the non-conductive substrate of Chan et al will be unaffected/unheated by the oscillating electromagnetic field. Applicant also argues there is no suggestion or motivation for combing Chen et al, Chan et al and Barret. The Examiner disagrees since Chan et al teach the step of localized heating the interconnect structures having ferromagneted material coated thereon on the substrate and Chen et al require heat treatment the interconnect structures on the substrate for improving the mechanical properties of the interconnect structures and Barret teaches the step of using heat-indicating paints to monitor the temperature of an object. Therefore the combination of disclosures taken as a whole would suggest to one of ordinary skill in the art to use the method of localized heating teached by Chan to heat treatment the interconnection structure of Chen to a desired temperature without heating or damaging the substrate or other structures on the substrate.